	Docket No.: YOR920020286US1
(Rev. 03-01)	TION FORM COVER SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
Tab settings + + + V V V	· · · · · · · · · · · · · · · · · · ·
To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.	
 Name of conveying party(ies): Hao Zeng 	2. Name and address of receiving party(ies):
2) International Business Machines Corporation	Name: International Business Machines Corporation
	Address: New Orchard Road
Additional names(s) of conveying party(ies)	۵ No
3. Nature of conveyance:	
Assignment Gereen	
Security Agreement Change of N	ame City: Armonk State/Prov.: NY
Other Agreement to Correct Invention Assignment	nt Country: USA ZIP: 10504
Execution Date: <u>1) May 14, 2004 2) July 11, 2005</u>	Additional name(s) & address(es) 🛛 Yes 🖵 No
4. Application number(s) or patent numbers(s):	
If this document is being filed together with a new ap	oplication, the execution date of the application is:
Patent Application No. Filing date	B. Patent No.(s)
10/340,761 January 13, 2003	
Additional	
Name and address of party to whom correspondenc concerning document should be mailed:	
Name: Sean M. McGinn	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. <u>34,386</u> Address: McGinn & Gibb	7. Total fee (37 CFR 3.41):\$ 40.00 Enclosed - Any excess or insufficiency should be credited or debited to deposit account
8321 Old Courthouse Road	Authorized to be charged to deposit account
Suite 200	8. Deposit account number:
City: Vienna State/Prov.: VA	50-0510
Country: USA ZIP: 22182-3817	
	DO NOT USE THIS SPACE
 Statement and signature. To the best of my knowledge and belief, the foregein of the original document. 	ng information is true and correct and any attached copy is a true copy
Phillip E. Miller	August 29, 2005
Name of Person Signing	Signature Date
	cluding cover sheet, attachments, and document:
Mail Stop Director of the L	PAssignment Recordation Services PATENT United States Patent and Trademark Office REEL: 016677 FRAME: 0816

Recordation Form Cover Sheet-Page 2

- 2. Name and Address of Receiving Party(ies):
 - Name: Louisiana Tech University
 - Address: 305 Wisteria Street
 - City: Ruston State/Prov.: Louisiana Country: USA Zip: 71272

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AGREEMENT TO CORRECT INVENTION ASSIGNMENT

This Agreement is between International Business Machines Corporation, a New York corporation having a place of business at New Orchard Road, Armonk, New York 10504, (hereinafter called "IBM"), Louisiana Tech University, a public Louisiana university having a place of business at 305 Wisteria Street, Ruston, Louisiana 71272, (hereinafter called "Louisiana Tech), and Inventor Hao Zeng (hereinafter called Zeng), of 238 Gallagher Street, Buchanan, New York, 10511, an employee of Louisiana Tech (the "Agreement to Correct Invention Assignment");

Whereas Zeng is co-inventor of a United States Patent Application Number 10/340,761, entitled "Process of Forming Magnetic Nanocomposites via Nanoparticle Self-Assembly" filed on January 13, 2003;

Whereas, IBM, Louisiana Tech and Zeng wish to correct an inadvertent error in the Assignment signed on January 6, 2003, (the Assignment Agreement) in which Zeng erroneously assigned his entire right, title and interest in the above application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of the above U.S. patent application, to IBM instead of the intended Assignee, Louisiana Tech;

Whereas, IBM based on information and belief agrees that the aforementioned assignment by Zeng to IBM was a result of an inadvertent error; and

Whereas, Zeng, and Louisiana Tech, as employer of Zeng at the time of the invention and of the filing of the above U.S. Patent Application, agree that Louisiana Tech was and is the intended Assignee of Zeng's entire right, title and interest under the Assignment Agreement.

Now, Therefore, IBM, Zeng and Louisiana Tech agree as follows:

That the Assignment Agreement be corrected to reflect Louisiana Tech as the proper Assignee of Zeng's assignment of his entire right, title and interest; that such a correction be effected in the Confirmatory Assignment attached hereto and signed by Zeng; and that the original assignment of right, title and interest to IBM from Co-inventor and employee of IBM, Shouheng Sun, under the Assignment Agreement, was and shall remain in full force and unaffected by this Agreement to Correct Invention Assignment.

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If any section of this Agreement to Correct Invention Assignment is found by competent authority to be invalid, illegal or unenforceable in any respect for any reason, the validity, legality and enforceability of such section in every other respect and the remainder of this Agreement to Correct Invention Assignment shall continue in effect so long as it still expresses the intent of the parties. If the intent of the parties cannot be preserved, this Agreement to Correct Invention Assignment shall be either renegotiated or terminated.

Nothing contained in this Agreement to Correct Invention Assignment shall be construed as conferring any rights by implication, estoppel or otherwise, under any intellectual property right, or any patents or patent applications, other than the aforementioned U.S. patent application.

This Agreement to Correct Invention Assignment shall not be binding upon the parties until it has been signed hereinbelow by or on behalf of each party.

This Agreement shall be construed, and the legal relations between the parties hereto shall be determined, in accordance with the law of the State of New York, United States of America, as such law applies to contracts signed and fully performed in the State of New York.

This Agreement, including the Confirmatory Assignment attached hereto, embodies the entire understanding of the parties with respect to the Assigned Patents, and replaces any prior oral or written communication between them.

Signed and Accepted:

Co-Inventor Hao Zeng

[Print Name] Richard M. Luchwiry International Business Machines Corp.

anif D. Keneau

[Print Name] PRESIDENT Louisiana Tech University

Date

Date

5/25/05

Date

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IBM Docket No. YOR920020285US1

CONFIRMATORY ASSIGNMENT

WHEREAS, I

Inventor Hao Zeng County of Westchester

of Buchanan (city) State of New York

have invented certain improvements in

"Process of Forming Magnetic Nanocomposites via Nanoparticle Self-Assembly"

and executed a United States patent application therefor on: January 13, 2003 and an Assignment therefor on: January 6, 2003;

Whereas, Louisiana Tech University, a public Louisiana university, having a place of business at 305 Wisteria Street, Ruston, Louisiana 71277, (hereinafter called "Louisiana Tech"), desires to acquire the entire, right, title and interest in said application and invention, and to any United States and foreign patents to be obtained therefor; and was and is the intended Assignee of Hao Zeng's entire right, title and interest in the Assignment of United States Patent Application Number 10/340,761;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby confirm that Louisiana Tech was and is the intended Assignee in my January 6, 2003 Assignment, and agree that my sale, assignment and transfer to Louisiana Tech, its successors and assigns, of the entire right, title and interest in said application and the invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said application is effective as of January 6, 2003, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to Louisiana Tech, its successors and assigns; and I hereby agree that Louisiana Tech may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Louisiana Tech.

Signed (Date Signing Assignment)

at

Yorktown Hts, NY May 14, 2004, on

Inventor, Hao Zeng

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RECORDED: 08/29/2005